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WaferAnalysis

Why?
How to use it?
How does it work?
How to define cuts?

Why? The WaferAnalysis program

- Motivation :
  - Objective and fast analysis
  - More than 10000 values per wafer need automation
  - reusable for module test

- Goal:
  - Analyze every scan data
  - Automatically apply cuts and judge the scan results
  - Automatically create scan data/result plots
  - Automatically create distribution plots for wafers/modules
  - Give easy access to the cut settings

How to use it? Installation and Interface

- **Stand alone installer:**

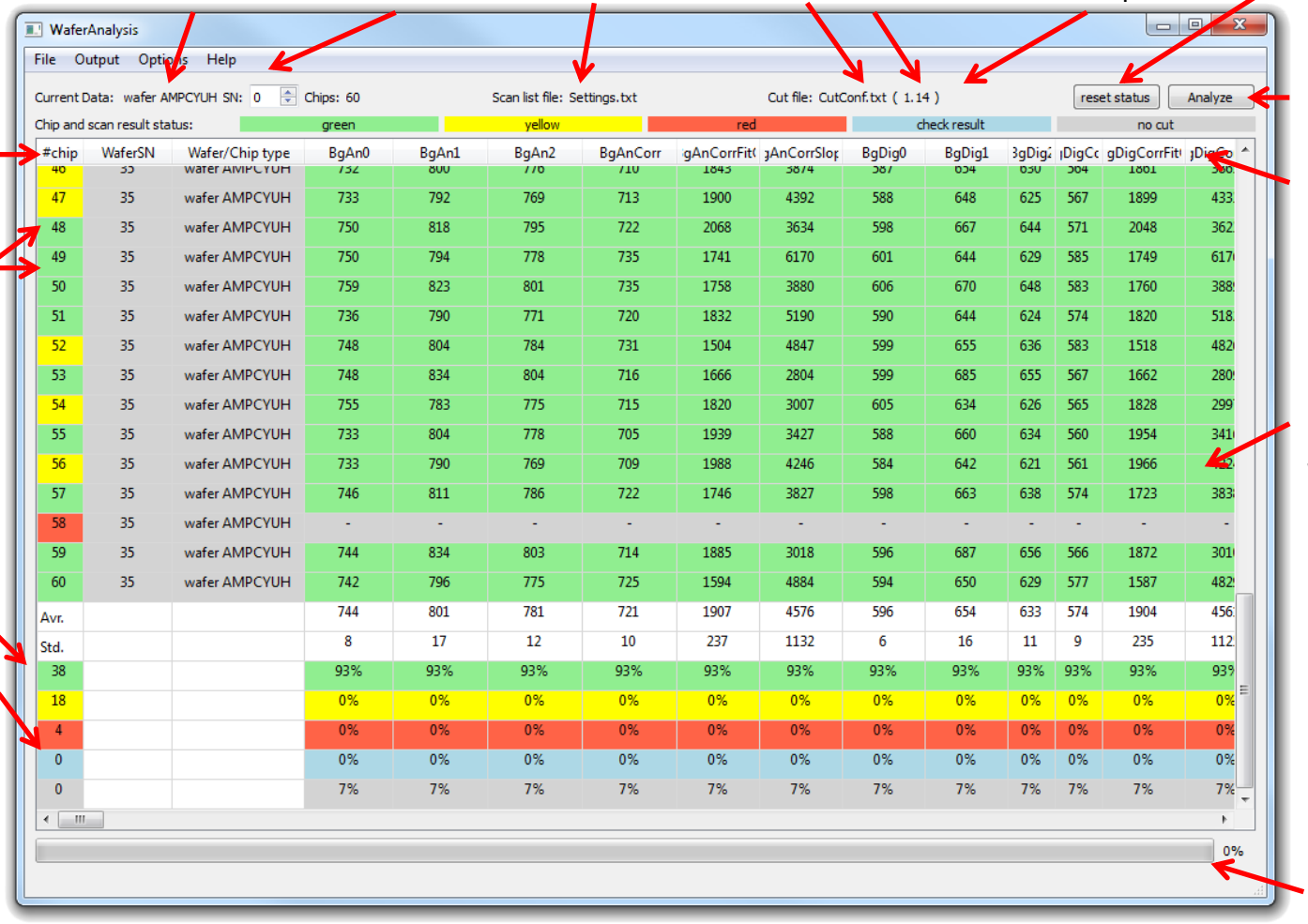
http://icwiki.physik.uni-bonn.de/svn/USBpixI4/host/trunk/Applications/Pixel/WaferAnalysis/setup/WaferAnalysisSetup_Beta.exe

- Qmake project File, **VS2008 project file** (with release, debug built) in:

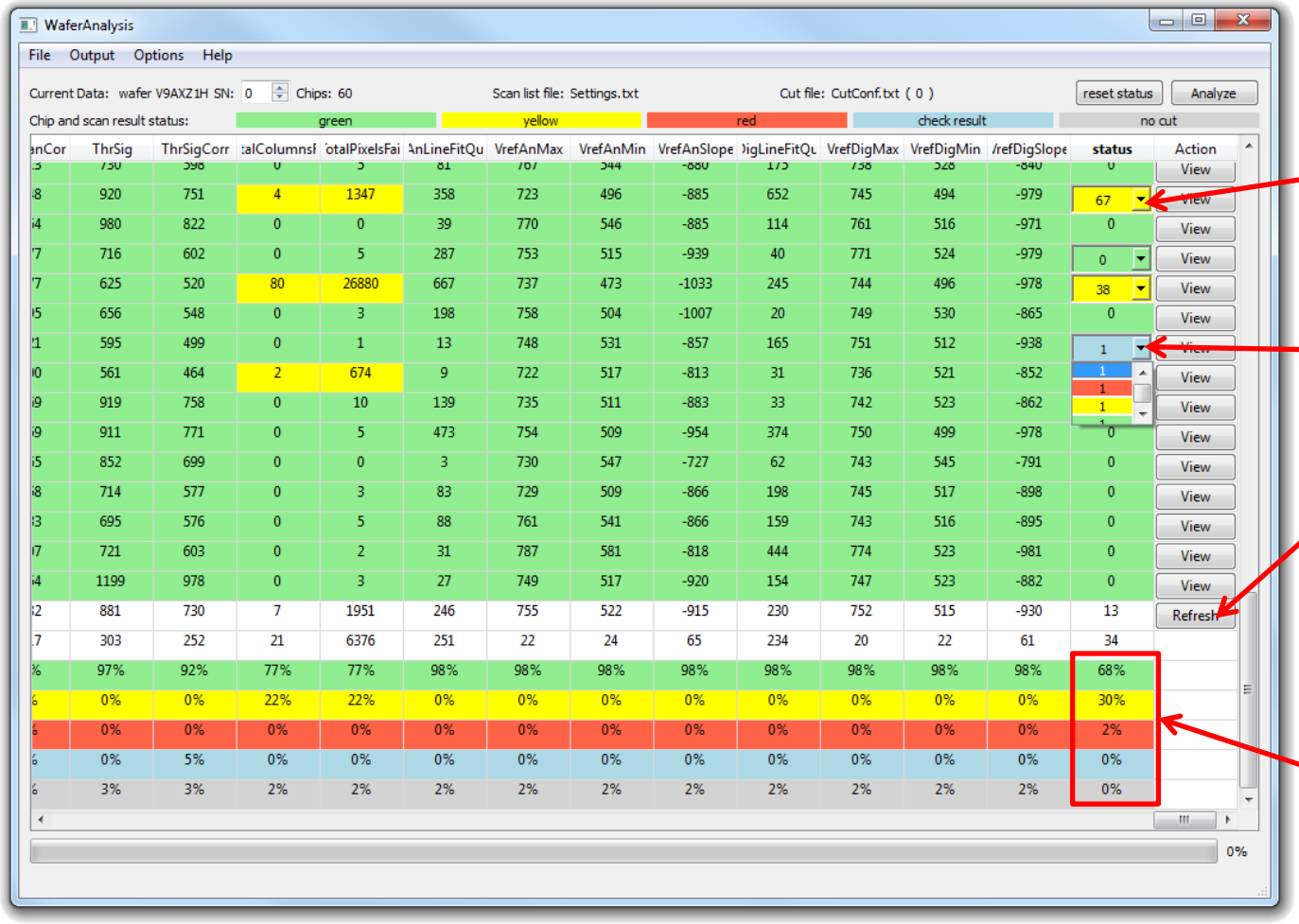
http://icwiki.physik.uni-bonn.de/svn/USBpixI4/host/trunk/Applications/Pixel/WaferAnalysis/

needs VS2008 professional or slight changes to the project for the .rc file

WaferAnalysis Interface I



WaferAnalysis Interface II



Chip/module status, number say how many scan results failed to be green

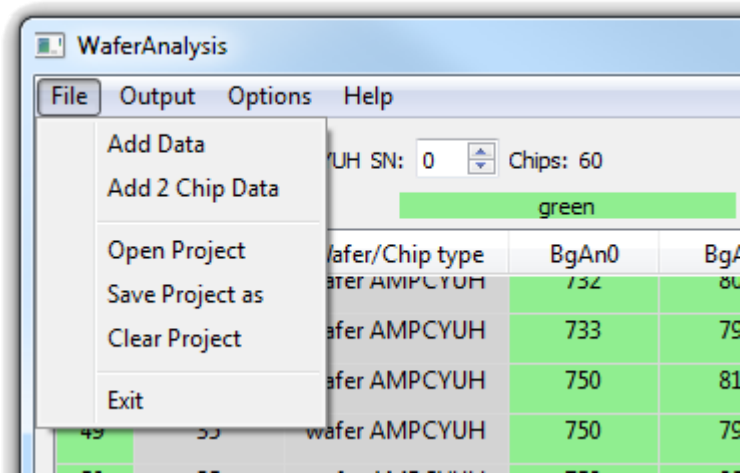
Blue Scan result values have to be checked and can be set manually

After scan result stati were changed press refresh to recalculate the statistics and redraw the table

Overall status statistic (**yield**)

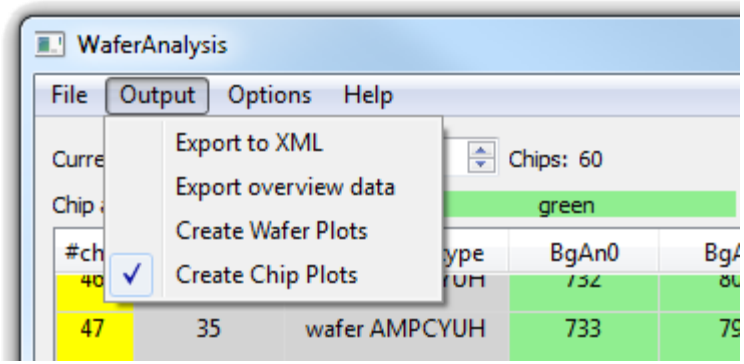
WaferAnalysis Interface (III: File)

- **Add Data**: Use to add a wafer data file (the other IC data files from the same wafer will be added automatically) or a single chip module file
- **Add 2 Chip Data**: Use to a double chip module file
- **Open Project:** opens a stored project file
- **Save Project:** Saves the actual project, don‘t forget the *.waprj suffix!
- **Clear Project:** resets the program to the status when it was started
- **Exit:** Well…



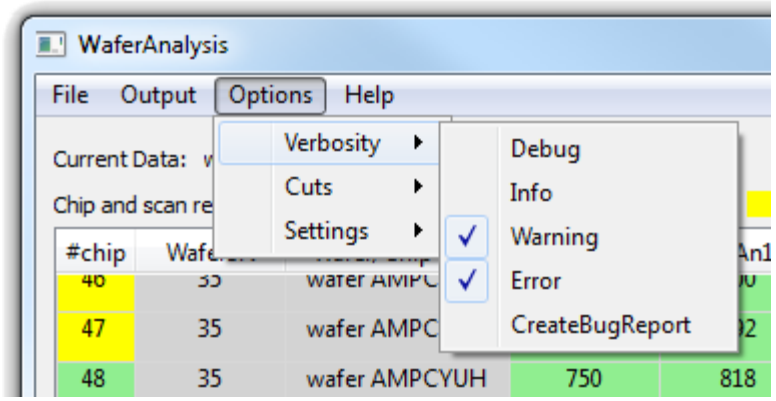
WaferAnalysis Interface (IV: Output)

- **Export to XML**: exports selected data to an xml file for the not existing IBL data base ☺ (ist totally useless)
- **Export Overview data:** Exports the Iref, Cap, SN, status data of one wafer into a text file for Fabian. Used for module production.
- **Create Wafer Plots:** Creates scan results distribution plots and wafer maps if more than one IC/module is loaded
- **Create Chip Plots:** Activate to automatically create a plot for each analysed scan



WaferAnalysis Interface (V: Options)

- **Verbosity**: changes the level how talkative the program is
  - *create debug report* writes every action into a text file stored in the exe folder
- **Cuts:**
  - *Open*: define the cut file used, otherwise cut file in the exe folder is used
  - Reload: read the cut file again and applies the IC cuts again, NOT the pixel/columns cuts (need new analysis)
- **Settings:**
  - *Open*: define the settings file used, otherwise settings file in the exe folder is used
  - Reload: read setting file again



The WaferAnalysis program I/O

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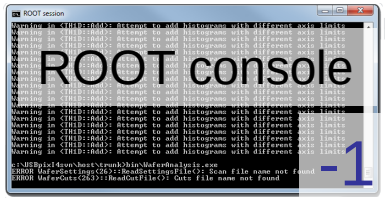
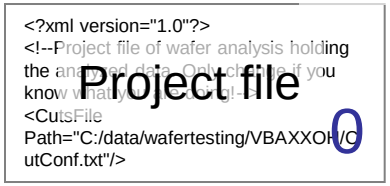
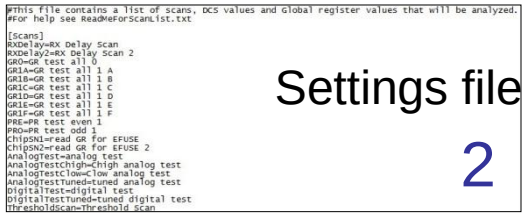
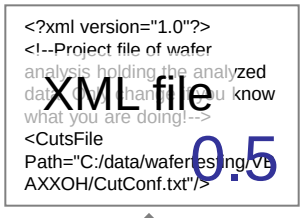
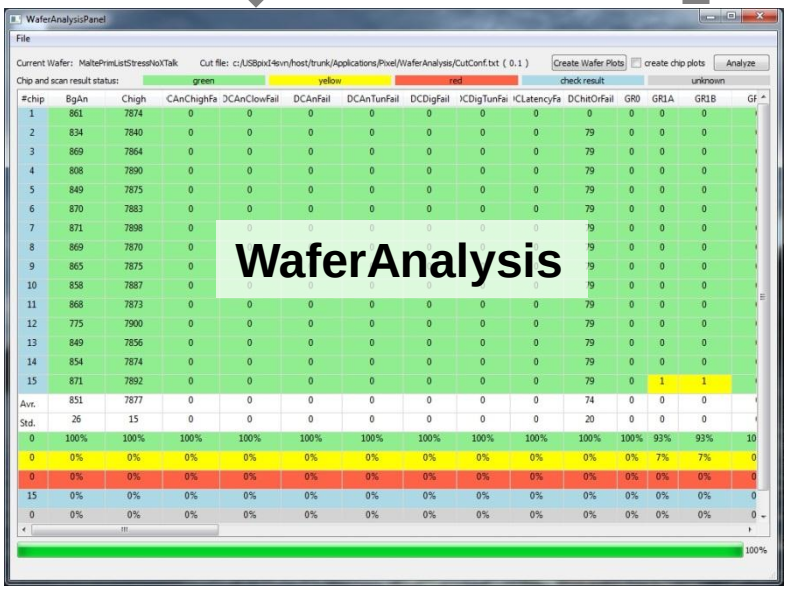


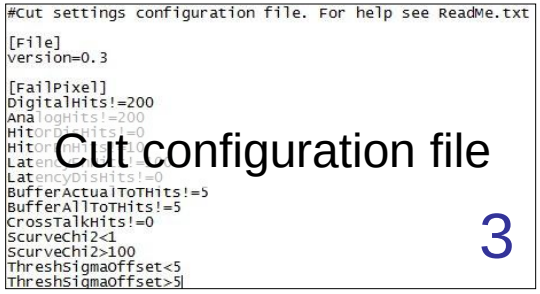


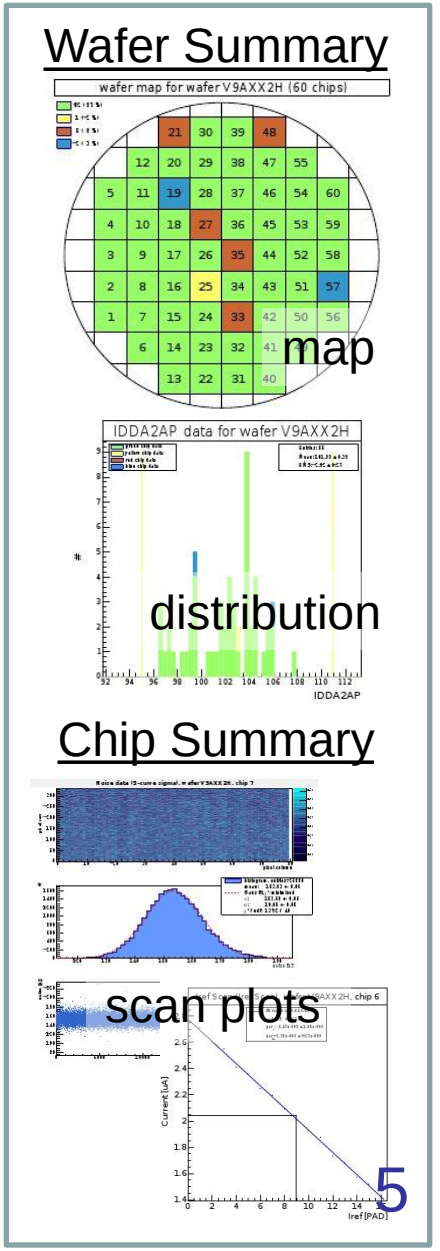
two files per chip
(scan data/cfg)





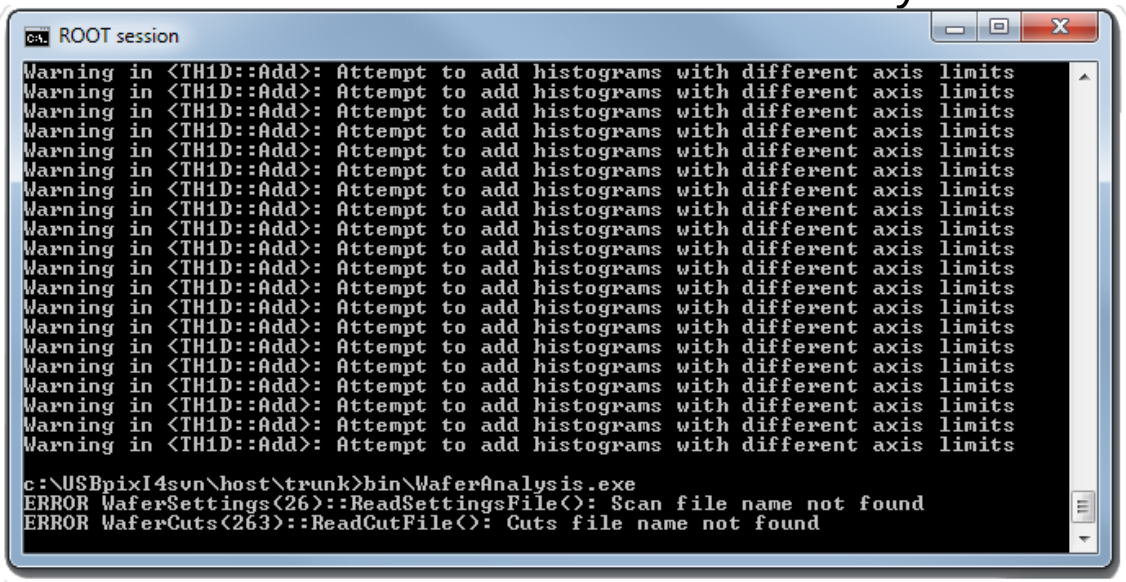






-1: ROOT console

- Is always open an additional window
- Shows (according to the verbosity setting): debug, info, warning, error messages
- Standard setting is: show warnings/errors
- The levels are choosen in a way that
  - **Warnings** are serious and can lead to a wrong judgement of the data!
  - **Errors** lead the program not to work in the intended way and have to be solved
  - **Infos** can have usefull additional but not necessary information
  - **Debug** will fill the console with in seconds and is only intended for program debug



0: Project files

- One project file (*.waprj) stores the analyzed data in a human readable way
- XML format
- The data/settings/cut files should be in the same folder/subfolder!

```
<?xml version="1.0"?>
<!--Project file of wafer analysis holding the
analyzed data. Only change if you know what you are
doing!-->
<CutsFile Path="CutConf.txt"/>

<SettingsFile Path="Settings.txt"/>

<Wafer Index="0">
    <WaferInfo SerialNumber="7" WaferName="VBAXXOH"
Chips="60"
FileGroupName="C:/data/wafertesting/VBAXXOH/data/waf
er_VBAXXOH"/>
</Wafer>

<Chip Index="0">
    <ChipInfo ChipNr="1.000000" WaferSN="7.000000"/>
    <BgAn Value="791.261971" Status="green"/>
    <BgDig Value="640.864015" Status="green"/>
    <CapCalib Value="6560.559455" Status="green"/>
    <CapCalibLineFitQuality Value="6.073999"
Status="green"/>
    <CapCalibST Value="8441.355705" Status="green"/>
    <ChipSN2 Value="449.000000" Status="green"/>
    <ColAnChighFail Value="0.000000"
Status="green"/>
    <ColAnClowFail Value="0.000000" Status="green"/>
    <ColAnFail Value="0.000000" Status="green"/>
```

0.5: XML export

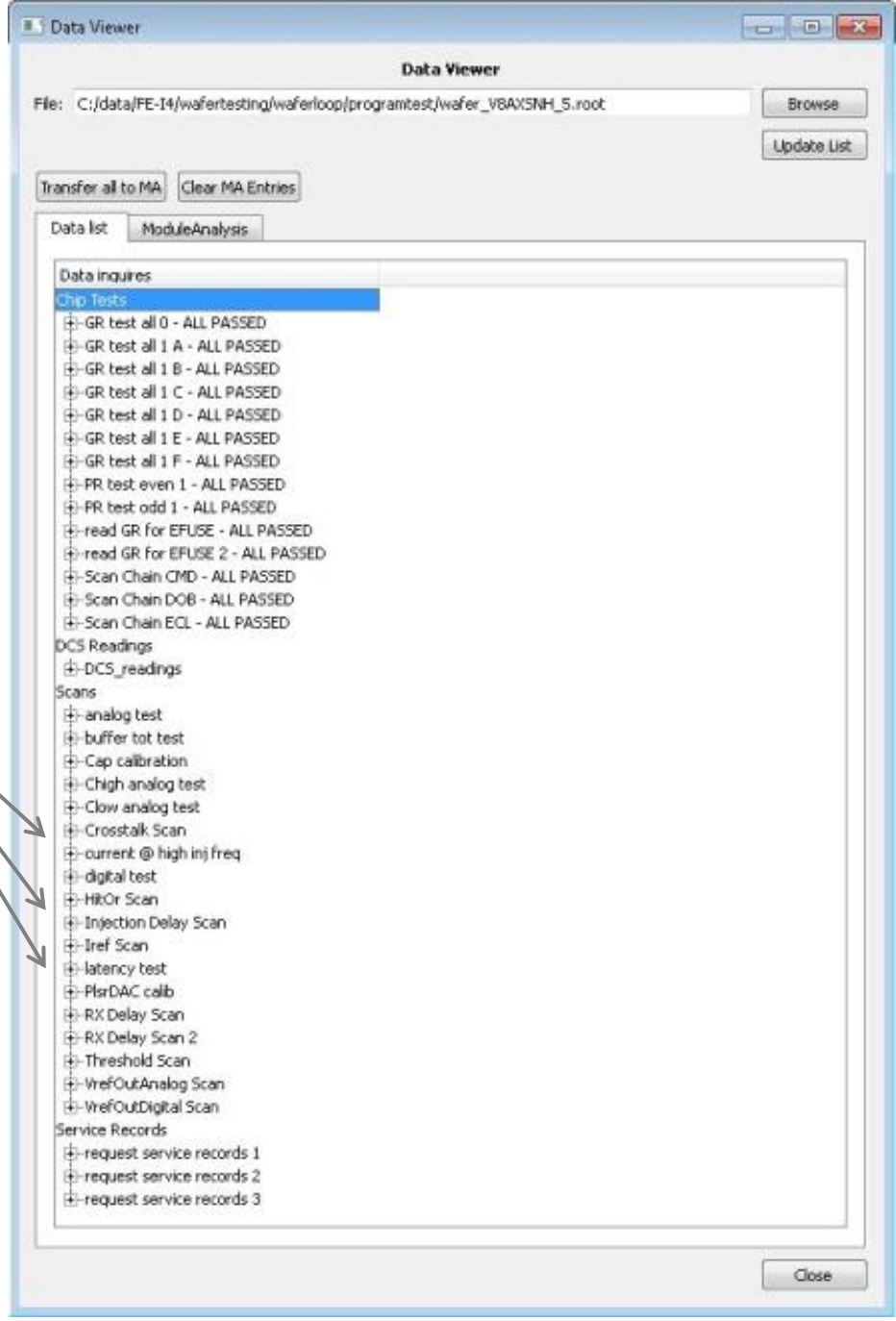
- For the IBL data base
- XML standard format
- The results to be exported can be set in the settings file in the section [XMLexport]
- **preview feature**, there won‘t be an IBL data base available in time…

```
<?xml version="1.0"?>

<!--Proof of concept FE-I4B wafer
testing XML for production data
base-->
-<Wafer> <WaferInfo SerialNumber="0"
WaferName="V4AXSSH"/>
<WaferStatistic RedChips="2"
YellowChips="4" GreenChips="54"/> -
<IC10> <SerialNumber ChipSN2=""/>
<DigitalCurrent
IDDA2CONF="111.377"/> <AnalogCurrent
IDDD2CONF="253.907"/> <RunAborted
RunAborted=""/> <Status status=""/>
</IC10> </Wafer>
```

1: STControl data

- ROOT DB format
- Two files per chip/module (scan data/cfg):
  - (wafer_)*name_chipNr*.root
  - (wafer_)*name_chipNr*.cfg.root
- Almost all data can be viewed with the WaferViewer (…/bin/WaferViewer.bat)
- Scan names; names are defined in the primitive list



2: Settings file

- Text file: ./Settings.txt
- Function:
  - Maps the STControl scan names to the WaferAnalysis scan names
  - Defines wich scans are analyzed!
  - Defines the post processing actions
  - … and much more (SEE README!)
- Has different sections sections
  - [Scans]: scan names
  - [DCScalues]: any single DCS measurement name
  - [ChipCalibration] e.g.:
    - PlsrDAC slope
    - Injection capacitance
  - [GlobalRegValues]:
    - Any global register name
  - …
- Read Me for more detailed informations: ./ReadMeForSettings.txt

```
[Scans]
RXDelay=RX Delay Scan
RXDelay2=RX Delay Scan 2
GR0=GR test all 0
GR1A=GR test all 1 A
GR1B=GR test all 1 B
GR1C=GR test all 1 C
GR1D=GR test all 1 D
GR1E=GR test all 1 E
GR1F=GR test all 1 F
PRE=PR test even 1
PRO=PR test odd 1
ChipSN1=read GR for EFUSE
ChipSN2=read GR for EFUSE 2
AnalogTest=analog test
AnalogTestChigh=Chigh analog test
AnalogTestClow=Clow analog test
AnalogTestTuned=tuned analog test
DigitalTest=digital test
DigitalTestTuned=tuned digital test
ThresholdScan=Threshold Scan
HitOrScan=HitOr Scan
BufferTest=buffer tot test
CrosstalkScan=Crosstalk Scan
LatencyTest=latency test
InjDelScan=Injection Delay Scan
InjFreqCurrScan=current @ high inj freq
CapCalibration=Cap calibration
PlsrDAC=PlsrDAC calib
VrefDig=VrefOutDigital Scan
VrefAn=VrefOutAnalog Scan
Cinj=Icap Scan
Iref=Iref Scan
TDACfastTune=TDAC fast tune
GDACfastTune=GDAC fast tune
CrossTalkScan=Crosstalk Scan
[DCSvalues]
IDDA1AP=IDDA1_UNCFG
IDDA2AP=IDDA2_UNCFG
IDDD1AP=IDDD1_UNCFG
IDDD2AP=IDDD2_UNCFG
IDDA1CONF=IDDA1_AFTER_CFG
IDDA2CONF=IDDA2_AFTER_CFG
IDDD1CONF=IDDD1_AFTER_CFG
IDDD2CONF=IDDD2_AFTER_CFG
BgAn=BgRef_An
BgDig=BgRef_Dig
[ChipCalibration]
#PlsrDACoffs=Misc_VcalGradient0
PlsrDACslop=Misc_VcalGradient1
```

README for settings file (part 1)

The Settings file contains different sections to set the wafer analysis program settings and options.

The name mapping sections are: [Scans] [DCSGraphAnaValues] [ChipCalibration] [GlobalRegValues] [PixCrtlSetting]
These sections contain a list of scans, DCS names, chip calibration, Global register names,
PixControler settings and Graph Analysis Value Names that will be analyzed.
It is possible to add any DCS name, chip calibration name, global register name, Graph Analysis Value and PixControler setting.
You just have to know the name used within the file (cfg or data) and define a name to use in the
Wafer probing program.
Example:
VthinAF=GlobalRegister_Vthin_AltFine (left side: your definition, right side: STControl value name)
You can also cut on this new defined value by writing it into the Cut file (here for example: VthinAF>100)
The scans cannot be defined this way (of cause) because the program has to analyze each scan
in a different way. Only the scans listed in the Scan list file are analyzed and you can not add new ones
without changing the program. To add new scans change the WaferAnalysis class.
As a check all scans (even if they do not require any analyzes) have to be listed in the Scan list file.
Otherwise the program will complain.
Example:
ThresholdScan=Threshold Scan
The left side of the scan definitions (here: ThresholdScan) should not be changed, otherwise
the scan is not recognized anymore!

The [AddToTotalCount] section:
Defines the pixel based scans (e.g. analog scan) to be added to the total failing pixel/column count. The name is the scan name not the STControl scan name. For example:
AnalogTest=1 (enabled)
uncommenting, not mentioning or AnalogTest=0: scan results is not added to the total failing pixel/column count

README for settings file (part 2)

The [PostProcessing] section:
Defines the post processing that is done after all results are available. These post processing steps are:
- CheckForAbortRun: the data of the chip is checked that the run got not aborted due to abort conditions and adds an abort flag to the chip results
- TotalCount: activates the total pixel/failing count and add the results to the chip results
- CorrectVrefs: does the GND shift correction to the Vrefs (tunable and fixed)
- CalculateResult: calculates a new results from other results, only / and * as mathematical operators are supported so far
- CompareResults: compares two results and changes the state of one results if they are not the same in a given error range

The post processing steps can be activated via:
PostProcessingName=1

The [CorrectBandGaps] section:
Defines the BGvoltages and currents that are used for the ground shift correction. Syntax:
BandGapVoltageName=NameOfCurrent1:NameOfCurrent2:...
The current are summend up and the plot has a point (BandGapVoltageName, SumOfTheCurrents).
A new result is added with the old result name + "Corr" appendix.
For example:
BgAn0=IDDA1AP:IDDA2AP:IDDD1AP:IDDD2AP

The [CorrectTunVrefs] section:
Defines the BGvoltages that are used at the moment when the TunVref was measured. Then the mean difference of the measured BGvoltages to the corrected on is used to correct the tunable Vrefs values.
A new result is added with the old result name + "Corr" appendix.
Example:
VrefDigMin:BgDig1:BgAn1
(takes the mean difference of the difference BgDig1 to the corrected BgDig and the BgAn1 to the correctd BgAn.
This is then applied to the VrefDigMin)

README for settings file (part 3)

The [CapacitanceCorrection] section:
Defines values that are used for the formular to calculate the injection capacitance out of the measured slope of the Icap scan. The value are:
Offset=-1360.
Dividor=1.081
Voltage=1000

The [CompareResults] section:
Defines values that are compared with each other in a certain range and the resulting status if they do not match.
Syntax: ResultValueName1=ResultValueName2:AllowedDifferenceInPersentOfResult2:StatusIfTheValuesDontMatch.
Example: PlsrDACslopeST=PlsrDACslope:3:Blue (PlsrDACslopeST is marked blue if it more than 3% off from PlsrDACslope)

The [ZoomDistributionPlots] section:
Defines the names of the results that are plotted in addition to the normal distribution plot with a zoom on the green chips.

The [ExportToXML] section:
Defines the names of the results that are exported to a XML file for the IBL construction data base. The file format is not the final one! So far its only "proof of concept"

3: Cut Configuration

- Text file: ./CutConf.txt
- Defines the cuts with 3 operators:
  <, >, !=
- Equations are indepented (ORed)!
- Has 6 sections
  - [File]: defines cut file version
  - [FailPixel]: cuts to define a failing pixel for each scan
  - [FailColumn]: number of failing pixel in a Column to bring the Column to fail (for each scan)
  - [Blue-, Red-, Yellow-Chip]:
    - Cuts that trigger to define the chip state
- Read Me: ./ReadMeForCutConf.txt

```
[File]
version=0.3

[FailPixel]
DigitalHits!=200
AnalogHits!=200
HitOrDisHits!=0
HitOrEnHits!=10
LatencyEnHits!=100
LatencyDisHits!=0
BufferActualToTHits!=5
BufferAllToTHits!=5
CrossTalkHits!=0
ScurveChi2<1
ScurveChi2>100
ThreshSigmaOffset<5
ThreshSigmaOffset>5
NoiseSigmaOffset>3
NoiseSigmaOffset<3

[FailDC]
DigitalFailPixel>20
HitOrDisFailPixel>20
HitOrEnFailPixel>5
LatencyEnFailPixel>10
LatencyDisFailPixel!=0
CrossTalkFailPixel>5
AnalogFailPixel>40
BufferActualToTFailPixel>10
BufferAllToTFailPixel>5
ThresholdFailPixel>50
ScurveFitFailPixel>20

[RedChip]
DigitalFailPixel>10000
AnalogFailPixel>10000
HitOrEnFailDC>0
HitOrDisFailPixel>0
BufferFailPixel>5
NoiseMean>1000
NoiseMeanSigma>50
ThresholdMeanSigma>100
ThresholdFailPixel>20000
IDDA1<-10
IDDA1>20
IDDA2>400
IDDD1>50
LatencyEnFailPixel>4000

[YellowChip]
NoiseMean>170
```

README for CutConf file (part 1)

#All possible parameter cuts for all sections [section]
#are listed below. The formatting of a parameter equation is:
#parameter<value; parameter>value or parameter!=value.
#The != operator is equal to the combination of the < and the > operator.
#The cut triggers if the parameter equation is true (example: AnalogHits!=200).
#The section triggers if any cut has triggered (ORed).
#If [BlueChip],[RedChip] and [YellowChip] do not trigger the chip is automatically green.
#If a parameter is mentioned more than once only the last definition
#is taken into account. The [File] area is special and only accepts = operators.
#You can also cut on DCSs and Global register values that you define in Settings.txt to
#be analyzed. These cuts belong to the [...Chip] section, the color is freely selectable.
#Some scans are done more than once with different configurations (HV applied, tuned, ...).
#Thus a Scan identifier[SI] can be used to distinguish these scans. The Scan identifier adds a word
#(like: tuned) to the usual name. For example
#ThresholdScanUntuned, ThresholdScanTuned (the [SI] is Untuned/Tuned). The [SI] can be empty.
#
#There are some scans that are only done in module testing. The cuts for these scans are mentioned
#separately at the end of this file.
#
#For any suggestions: pohl@physik.uni-bonn.de

[File]
version=0.1(version of the file, PLEASE INCREASE IN CutConf.txt IF ANYTHING CHANGED THERE)

[FailPixel]
AnalogHits(number of hits in the analog test, usually 200)
DigitalHits(number of hits in the digital test, usually 200)
HitOrEnHits (number of hits in the hit Or test with disabled hit or, usually 0)
HitOrDisHits (number of hits in the hit Or test with enabled hit or, usually 10)
LatencyEnHits (number of hits in the latency test that are enabled for every latency value, usually 100)
LatencyDisHits (number of hits in the latency test that are disabled for every latency value, usually 0)

README for CutConf file (part 2)

CrossTalk[SI]Hits (number of hits in the cross talk scan, usually 0)
DisabledHits (number of hits in the disabled pixel scan, usually 0)
BufferActualToTHits (number off hits in the buffer test for the actual ToT, usually close to 5)
Scurve[SI]Chi2(chi square of the s curve fit in the threshold scan, take care: failed fits sometimes have a chi2 = -1,0)
Thresh[SI]SigmaOffset(distance between pixel threshold and mean threshold, distance = ThreshSigmaOffset * sigma of threshold distribution)
Noise[SI]SigmaOffset(distance between pixel noise and mean noise, distance = NoiseSigmaOffset * sigma of noise distribution)
ESLhits (number of hits in the check Event Size Limit test, usually either 1 (1/2 of the pixels of first DC) or 0 (others))

[FailColumn]
AnalogFailPixel(number of pixel that pass the analog [FailPixel] criterion)
DigitalFailPixel(number of pixel that pass the digital [FailPixel] criterion)
HitOrEnFailPixel (number of pixel that pass the hit Or enable [FailPixel] criterions)
HitOrDisFailPixel (number of pixel that pass the hit Or disable [FailPixel] criterions)
LatencyEnFailPixel (number of enabled pixel that pass the enable latency [FailPixel] criterion)
LatencyDisFailPixel (number of disabled pixel that pass the disable latency [FailPixel] criterion)
BufferActualToTFailPixel (number of pixel that pass the buffer actual ToT [FailPixel] criterion)
BufferAllToTFailPixel (number of pixel that pass the buffer all ToT [FailPixel] criterion)
CrossTalk[SI]FailPixel (number of pixel that pass the cross talk scan [FailPixel] criterion)
DisabledFailPixel (number of pixel that pass the disabled pixel scan [FailPixel] criterion)
PixRegENABLEFailPixel>10 (total number of pixel that fail the pixel register tests for latch ENABLE)
PixRegCAP0FailPixel>10 (total number of pixel that fail the pixel register tests for latch CAP0)
PixRegCAP1FailPixel>10 (total number of pixel that fail the pixel register tests for latch CAP1)
PixRegILEAKFailPixel>10 (total number of pixel that fail the pixel register tests for latch ILEAK)
PixRegTDAC0FailPixel>10 (total number of pixel that fail the pixel register tests for latch TDAC0)
PixRegTDAC1FailPixel>10 (total number of pixel that fail the pixel register tests for latch TDAC1)
PixRegTDAC2FailPixel>10 (total number of pixel that fail the pixel register tests for latch TDAC2)
PixRegTDAC3FailPixel>10 (total number of pixel that fail the pixel register tests for latch TDAC3)
PixRegTDAC4FailPixel>10 (total number of pixel that fail the pixel register tests for latch TDAC4)
PixRegFDAC0FailPixel>10 (total number of pixel that fail the pixel register tests for latch FDAC0)
PixRegFDAC1FailPixel>10 (total number of pixel that fail the pixel register tests for latch FDAC1)
PixRegFDAC2FailPixel>10 (total number of pixel that fail the pixel register tests for latch FDAC2)
PixRegFDAC3FailPixel>10 (total number of pixel that fail the pixel register tests for latch FDAC3)

README for CutConf file (part 3)

[RedChip]
TotalPixelsFail (the total number of different pixels that fail the scans)
TotalColumnsFail(the total number of different columns that fail the scans)
Noise[SI]Mean(mean noise of the chip)
Noise[SI]Sigma(noise distribution gaus fit sigma of the chip)
Noise[SI]DistFitQuality(fit quality in chi2/ndf of the noise distribution fit)
Noise[SI]FailPixel (number of pixels that the noise [FailPixel] criterion)
Threshold[SI]Mean(mean threshold of the chip)
Threshold[SI]Sigma(threshold distribution gaus fit sigma of the chip)
Threshold[SI]DistFitQuality(fit quality in chi2/ndf of the threshold distribution fit)
Threshold[SI]FailPixel (number of pixels that the threshold [FailPixel] criterion)
Scurves[SI]Chi2Mean (mean chi2 of the chip for the s-curve fits)
Scurves[SI]Chi2Sigma (chi2 distribution gaus fit sigma of the chip)
AnalogFailPixel(number of pixel that pass the analog [FailPixel] criterion)
AnalogChighFailPixel (number of pixel that pass the analog [FailPixel] criterion)
AnalogClowFailPixel (number of pixel that pass the analog [FailPixel] criterion)
DigitalFailPixel(number of pixel that pass the digital [FailPixel] criterion)
HitOrEnFailPixel (number of pixel that pass the hit Or enable [FailPixel] criterions)
HitOrDisFailPixel (number of pixel that pass the hit Or disable [FailPixel] criterions)
HitOrEnFailColumn (total number of columns that pass the hit Or enable [FailColumn] criterion)
HitOrDisFailColumn (total number of columns that pass the hit Or enable [FailColumn] criterion)
LatencyEnFailPixel (number of enabled pixel that pass the enable latency [FailPixel] criterion)
LatencyDisFailPixel (number of disabled pixel that pass the disable latency [FailPixel] criterion)
LatencyFailColumn (total number of columns that pass the hit Or enable/disable [FailColumn] criterion)
BufferActualToTFailPixel (number of pixel that pass the buffer actual ToT [FailPixel] criterion)
BufferActToTFailColumn (total number of columns that pass the BufferActualToTFailPixel [FailColumn] criterion)
CrossTalk[SI]FailPixel (number of pixel that pass the cross talk test [FailPixel] criterion)
DisabledFailPixel (number of pixel that pass the disabled pixel scan [FailPixel] criterion)
DisabledFailColumns (total number of columns that pass the disabled pixel scan [FailPixel] criterion)
ScurveFitFailPixel(number of pixel that pass the scurve [FailPixel] criterion)
AnalogFailColumns(number of double columns that pass the analog [FailColumn] criterion)
DigitalFailColumns(number of double columns that pass the digital [FailColumn] criterion)

README for CutConf file (part 4)

HitOrFailD (number of pixel that pass the hit Or [FailColumn] criterion)
BufferFailColumns (number of double columns that pass the buffer test [FailColumn] criterion)
InjDelMinLVL1 (minimum mean LVL1 delay)
InjDelMaxLVL1 (maximum mean LVL1 delay)
InjDelMonotony (value describing the monotony, usually 0)
SRX_Y (the service record number for service record Y [0:31] and for the SR request X)
IDDA1(current consumption on analog 1 channel in mA)
IDDA2(current consumption on analog 2 channel in mA)
IDDD1(current consumption on digital 1 channel in mA)
IDDD2(current consumption on digital 2 channel in mA)
BgAnalog(voltage of the analog band gap reference mV)
BgDigital(voltage of the digital band gap reference mV)
PixelRegError(number of pixels with a pixel register error)
GlobalRegError(number of global register error)
RXvalley (distance in bins [1..25] with a delay value without communication errors)
VrefDigMin (minimum value measured for the digital voltage reference)
VrefDigMax (maximum value measured for the digital voltage reference)
VrefDigSlope (slope of the line fit for the Vref digital DAC transfer function, BE AWARE: in uV/DAC)
VrefDigLineFitQuality (chi2/nfd*1e6 for the line fit of the Vref digital DAC transfer function)
VrefAnMin (minimum value measured for the analog voltage reference)
VrefAnMax (maximum value measured for the analog voltage reference)
VrefAnSlope (slope of the line fit for the Vref analog DAC transfer function, BE AWARE: in uV/DAC)
VrefAnLineFitQuality (chi2/nfd*1e6 for the line fit of the Vref analog DAC transfer function)
Iref (best Iref value that can be set, BE AWARE: in nA)
IrefMin (minimum value measured for the current reference, BE AWARE: in nA)
IrefMax (maximum value measured for the current reference, BE AWARE: in nA)
IrefSlope (slope of the line fit for the Iref transfer function, BE AWARE: in nA/DAC)
IrefLineFitQuality (chi2/nfd*1e12 for the line fit of the Iref transfer function)
PlsrDACmin (minimum value measured for the PlsrDAC scan, BE AWARE: in mV)
PlsrDACmax (maximum value measured for the PlsrDAC scan, BE AWARE: in mV)
PlsrDACslope (slope of the line fit for the PlsrDAC transfer function, BE AWARE: in uV/DAC)
PlsrDACkink (kink of the PlsrDAC transfer function, BE AWARE: arbitrary unit)
PlsrDAClineFitQuality (chi2/nfd*1e6 for the line fit of the PlsrDAC transfer function)

README for CutConf file (part 5)

IcapSlope (slope of the line fit for the Icap data, BE AWARE: in nA/DAC)
IcapLineFitQuality (chi2/nfd*1e12 for the line fit of the Icap data)
OwnDefinedRegisterName (has to be defined in ScanList.txt)
OwnDefinedPixelCalibName (has to be defined in ScanList.txt, BE AWARE: the values read are multiplied by 1000)
HighFreqCurr (current consumption in the high trigger frequency scan)
SC_CMD (scan chain CMD, 0: fail, 1: pass, 2: no data)
SC_DOB (scan chain DOB, 0: fail, 1: pass, 2: no data)
SC_ECL (scan chain ECL, 0: fail, 1: pass, 2: no data)

[YellowChip]see [RedChip] parameters

[BlueChip]see [RedChip] parameters, but due to the fact that blue chip indicate analyzes issues only fit quality cuts and values that should not occure make sense here

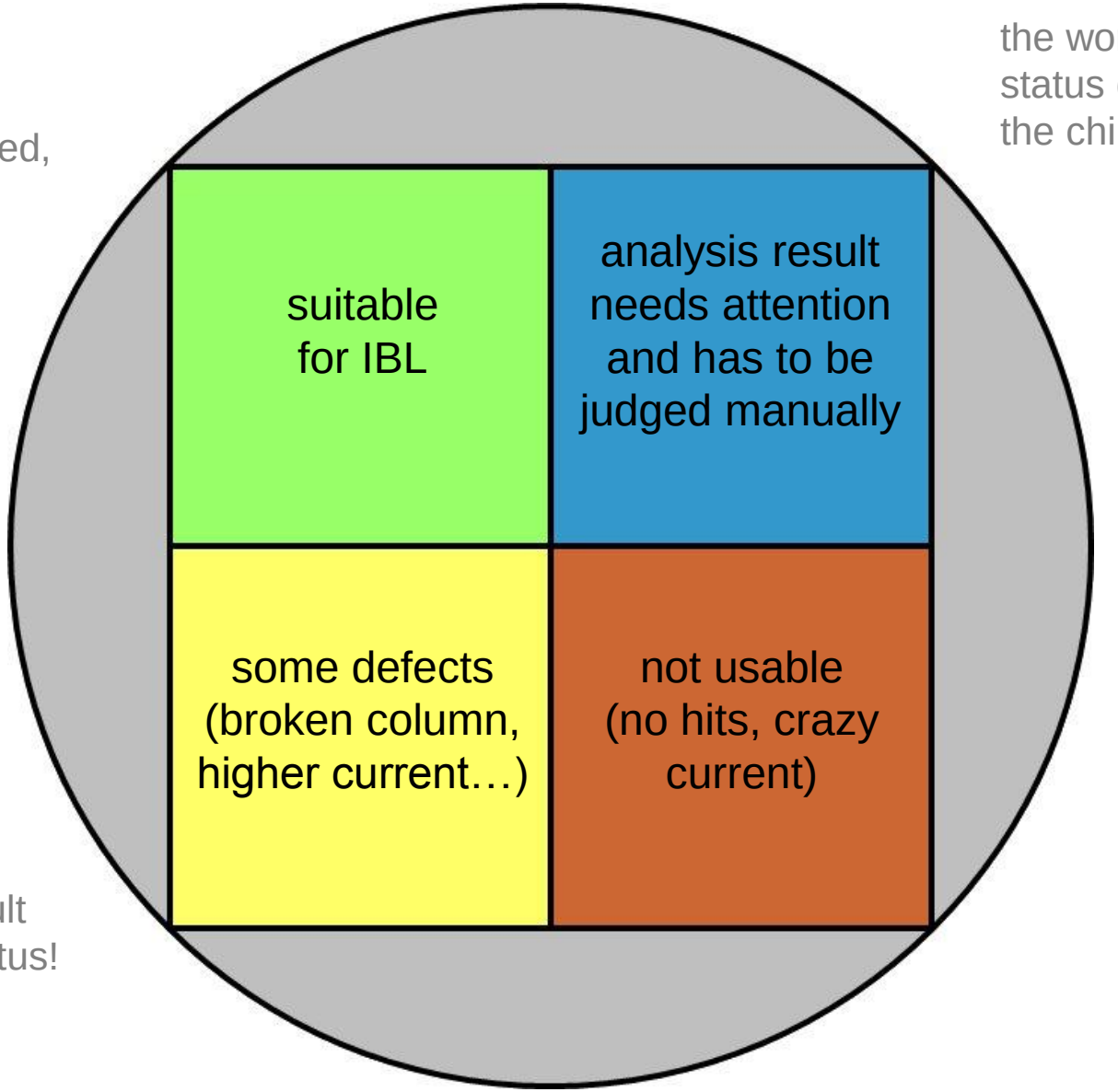
#cuts for module scans
[FailPixel]
BumpConNoiDiff (difference of the noise in e for two threshold scans with and without HV)
BumpConScurveChi2 (chi square of the s curve fit in the threshold scans, take care: failed fits sometimes have a chi2 = -1,0)
[FailColumn]
BumpConFailPixel (number of pixel that pass the bump connection noise difference [FailPixel] criterion)
[RedChip]
BumpConFailPixel (number of pixel that pass the bump connection noise difference [FailPixel] criterion)
BumpConFailColumn (total number of columns that pass the BumpConFailPixel [FailColumn] criterion)

Cut scheme of WaferAnalysis

Color definition, chip states

The final chip status is:
green, yellow, red, NOT blue

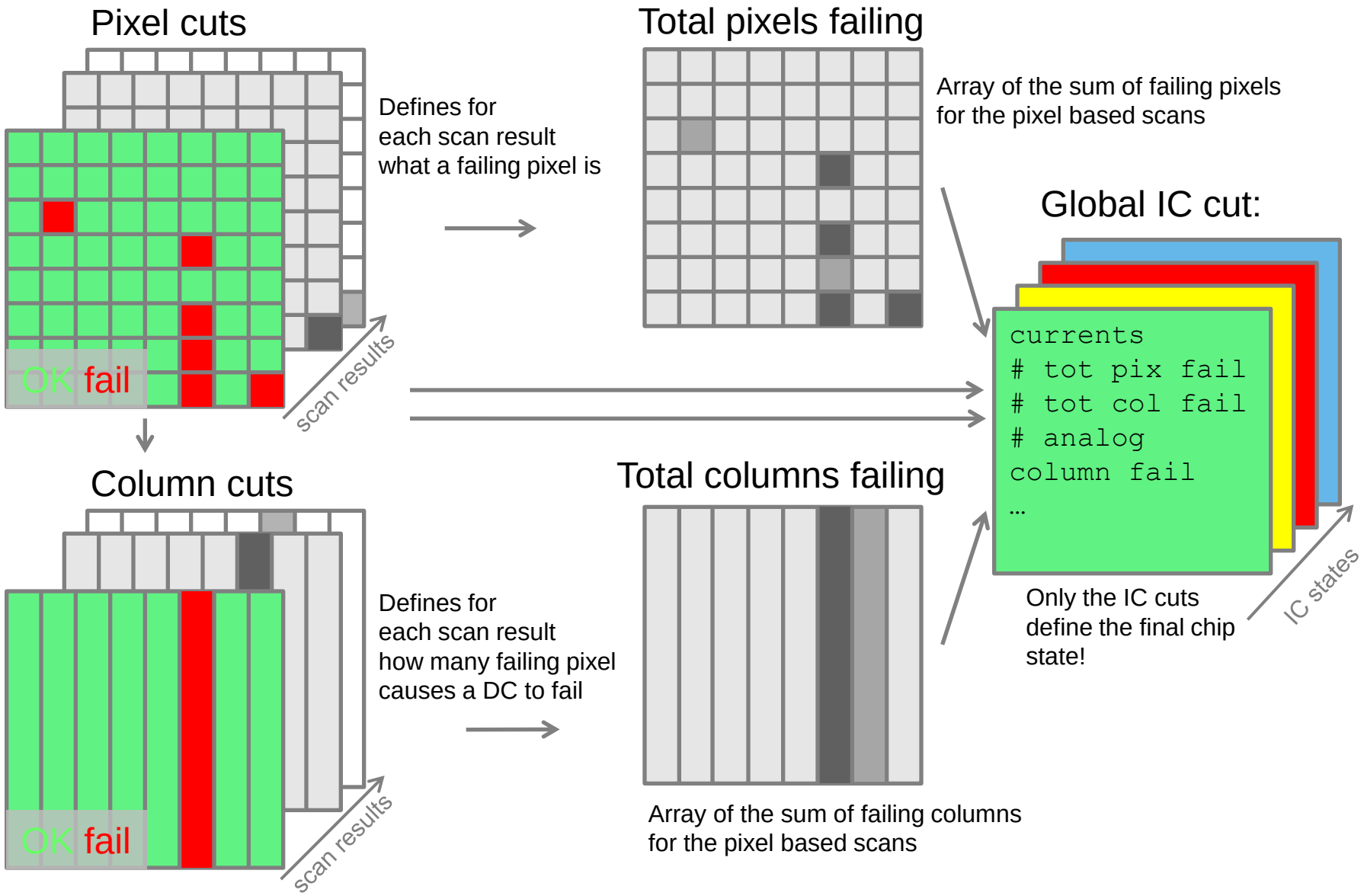
the worst result status defines the chip status



Each scan result has its own status!
Blue is allowed here

Cut scheme of WaferAnalysis

pixel, column and global IC cuts



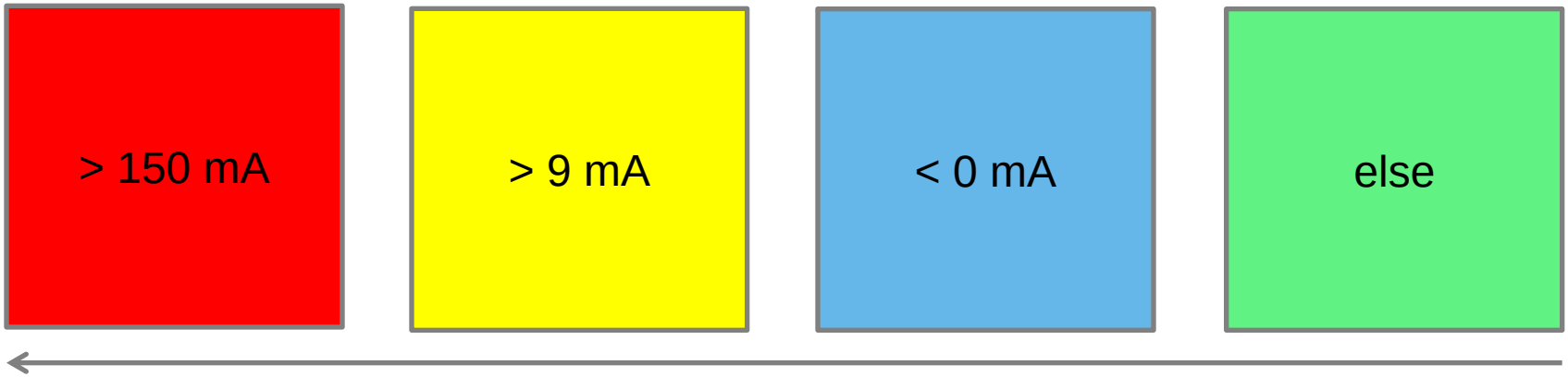
Cut scheme of WaferAnalysis

IC cuts

Defines the valid value range for each scan result and for the IC status: blue, red, yellow

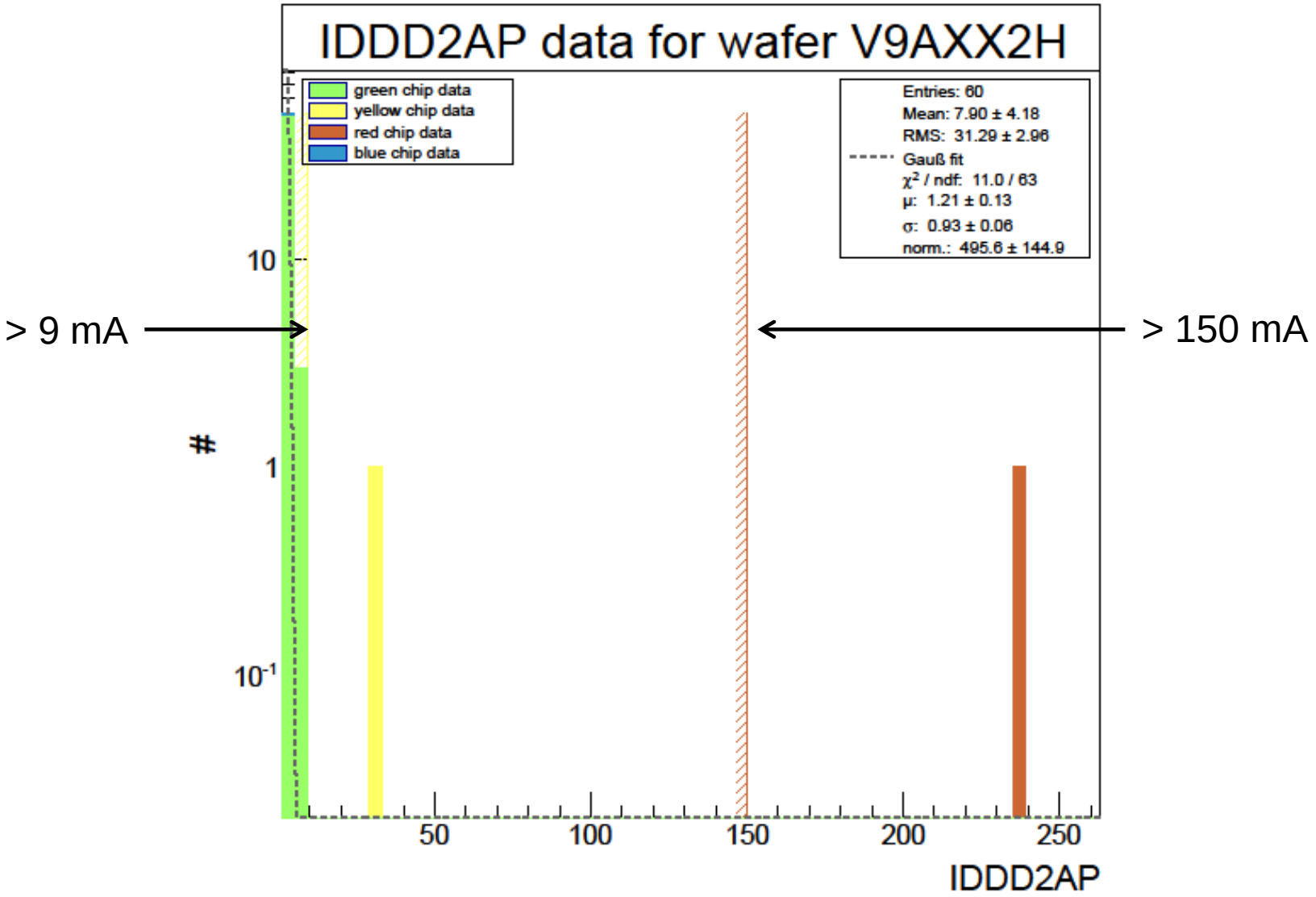
IC cuts on results of the following scans:
- powering: current consumption, reference current, reference voltages
- global register, scan chain, service records, PlsrDAC, injection capacitance
- injection delay scan, threshold scan (noise, threshold)
- #total pixel failing, #total columns failing
- #pixel failing for some scans, #columns failing in some scans

Example: analog current after power up



Cut scheme of WaferAnalysis

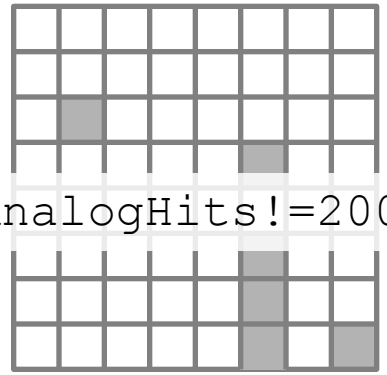
Global IC cuts example: analog current after power up



Cut scheme of WaferAnalysis

Pix/col based cuts example: Analog Scan

Pixel cuts



Defines here:
what is a analog scan failing pixel

`AnalogHits!=200`

add to

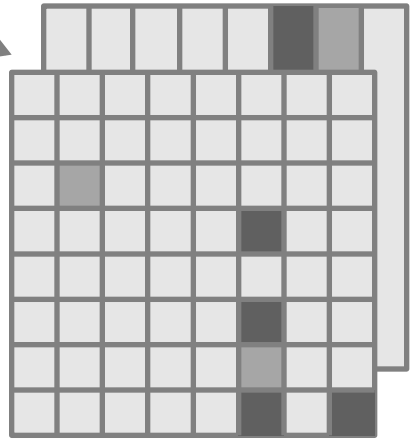
Column cuts

add to

Defines here:
How many pixel in one column have to fail the analog scan to let the DC fail

`AnalogFailPixel>20`

Total pix/col failing



Global IC cuts

Defines here for the analog scan result and the blue, red, yellow IC states:
- how many pixels can fail in the analog test
- how many columns can fail in the analog test

And defines the total cuts

`AnalogFailPixel>26880`
`AnalogFailColumns>80`

`AnalogFailPixel>10000`

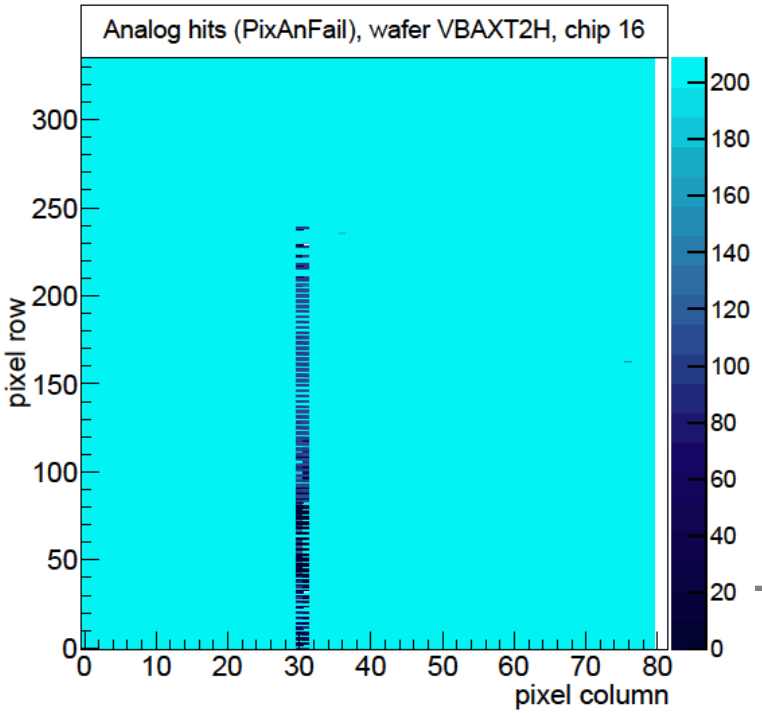
`TotalFailPixel>108`
`TotalFailColumns!=0`
`AnalogFailColumns!=0`

`else`

Cut scheme of WaferAnalysis

Pixel based cuts example: Analog Scan

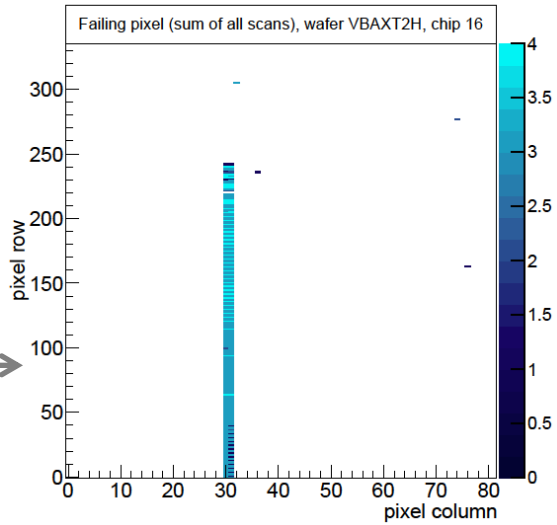
Pixel cuts

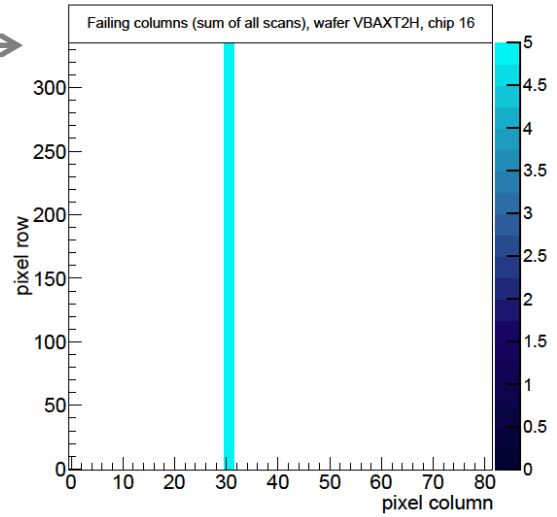


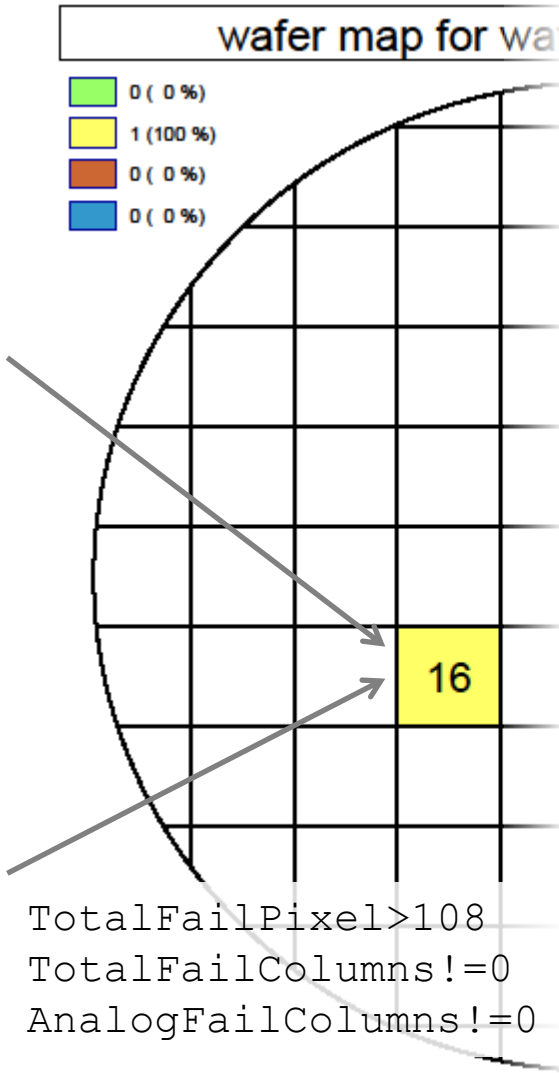
AnalogHits!=200
→466 analog failing pixels

Analog failing pixels > 20
→ 2 analog failing columns

Total pix/col failing







TotalFailPixel>108
TotalFailColumns!=0
AnalogFailColumns!=0

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Please report all bugs to:
pohl@physik.uni-bonn.de